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## 2.4 GHz IEEE Std. 802.15.4™ RF Transceiver Module

### Features:

- IEEE Std. 802.15.4™ Compliant RF Transceiver
- Supports ZigBee®, MiWi™, MiWi™ P2P and Proprietary Wireless Networking Protocols
- Small Size: 0.7" x 1.1" (17.8 mm x 27.9 mm), Surface Mountable
- Integrated Crystal, Internal Voltage Regulator, Matching Circuitry and PCB Antenna
- Easy Integration into Final Product – Minimize Product Development, Quicker Time to Market
- Radio Regulation Certification for United States (FCC), Canada (IC) and Europe (ETSI)
- Compatible with Microchip Microcontroller Families (PIC16F, PIC18F, PIC24F/H, dsPIC33 and PIC32)
- Up to 400 ft. Range

### Operational:

- Operating Voltage: 2.4-3.6V (3.3V typical)
- Temperature Range: -40°C to +85°C Industrial
- Simple, Four-Wire SPI Interface
- Low-Current Consumption:
  - RX mode: 19 mA (typical)
  - TX mode: 23 mA (typical)
  - Sleep: 2 µA (typical)

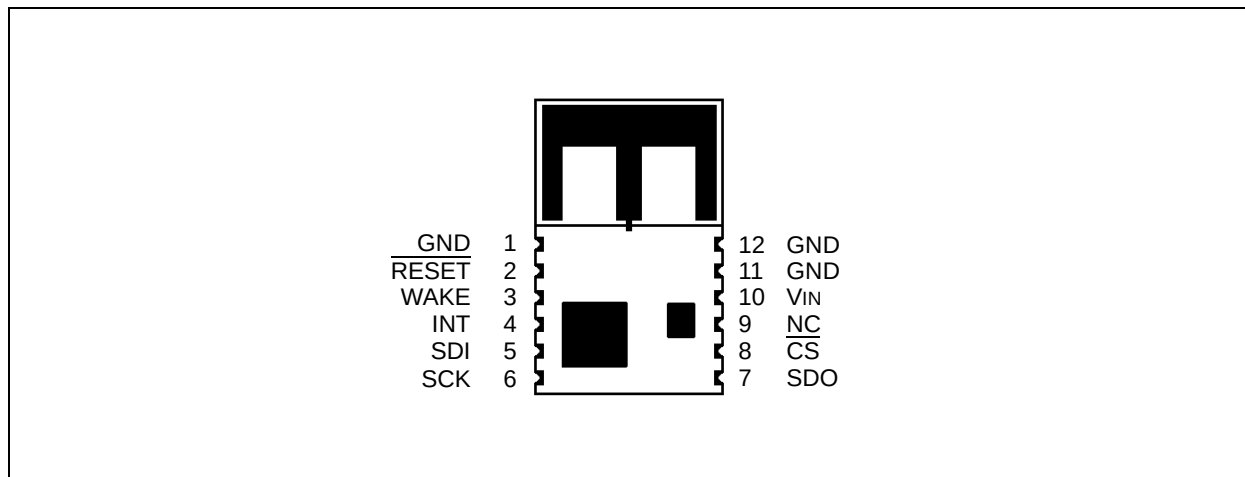
### RF/Analog Features:

- ISM Band 2.405-2.48 GHz Operation
- Data Rate: 250 kbps
- -94 dBm Typical Sensitivity with +5 dBm Maximum Input Level
- +0 dBm Typical Output Power with 36 dB TX Power Control Range
- Integrated Low Phase Noise VCO, Frequency Synthesizer and PLL Loop Filter
- Digital VCO and Filter Calibration
- Integrated RSSI ADC and I/Q DACs
- Integrated LDO
- High Receiver and RSSI Dynamic Range

### MAC/Baseband Features:

- Hardware CSMA-CA Mechanism, Automatic ACK Response and FCS Check
- Independent Beacon, Transmit and GTS FIFO
- Supports all CCA modes and RSS/LQI
- Automatic Packet Retransmit Capable
- Hardware Security Engine (AES-128) with CTR, CCM and CBC-MAC modes
- Supports Encryption and Decryption for MAC Sublayer and Upper Layer

**FIGURE 1: PIN DIAGRAM**



## Table of Contents

|                                            |    |
|--------------------------------------------|----|
| 1.0 Device Overview .....                  | 3  |
| 2.0 Circuit Description .....              | 7  |
| 3.0 Regulatory Approval.....               | 15 |
| 4.0 Electrical Characteristics .....       | 19 |
| Appendix A: Revision History.....          | 21 |
| Index .....                                | 23 |
| The Microchip Web Site.....                | 25 |
| Customer Change Notification Service ..... | 25 |
| Customer Support.....                      | 25 |
| Reader Response .....                      | 26 |
| Product Identification System.....         | 27 |

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## 1.0 DEVICE OVERVIEW

The MRF24J40MA is a 2.4 GHz IEEE Std. 802.15.4™ compliant, surface mount module with integrated crystal, internal voltage regulator, matching circuitry and PCB antenna. The MRF24J40MA module operates in the non-licensed 2.4 GHz frequency band and is FCC, IC and ETSI compliant. The integrated module design frees the integrator from extensive RF and antenna design, and regulatory compliance testing, allowing quicker time to market.

The MRF24J40MA module is compatible with Microchip's ZigBee®, MiWi™ and MiWi P2P software stacks. Each software stack is available as a free download, including source code, from the Microchip web site <http://www.microchip.com/wireless>.

The MRF24J40MA module has received regulatory approvals for modular devices in the United States (FCC), Canada (IC) and Europe (ETSI). Modular approval removes the need for expensive RF and antenna design and allows the end user to place the

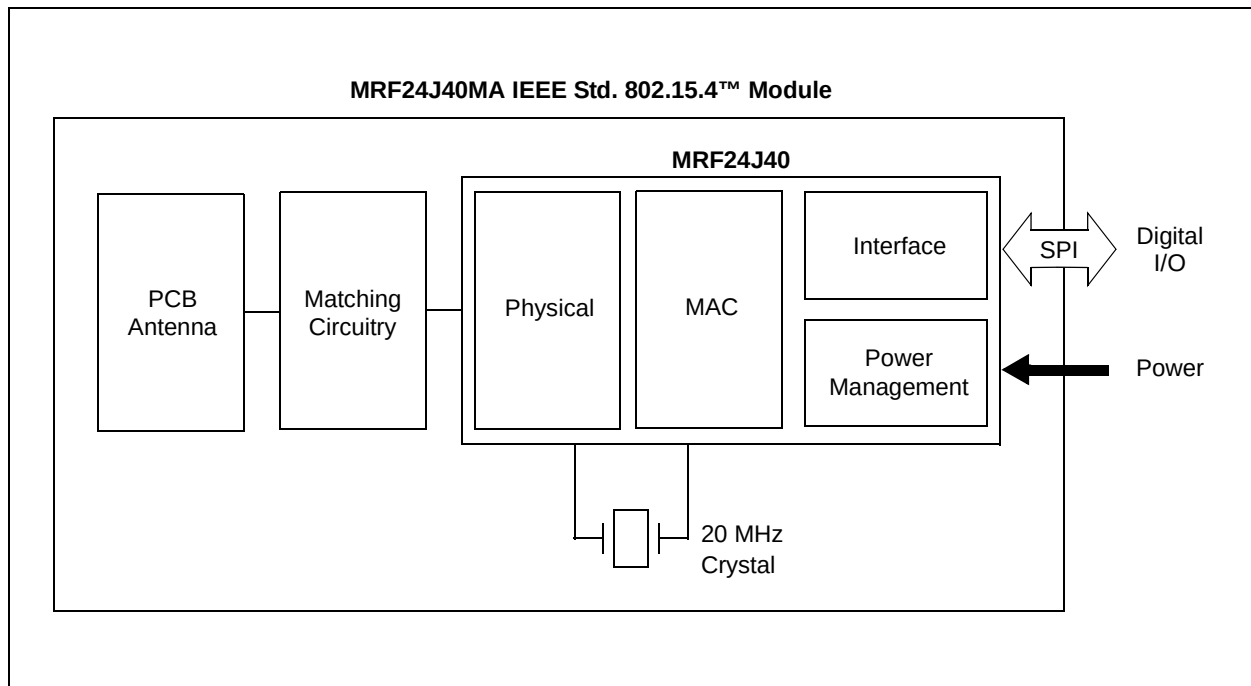
MRF24J40MA module inside a finished product and not require regulatory testing for an intentional radiator (RF transmitter). See **Section 3.0 “Regulatory Approval”** for specific requirements to be followed by the integrator.

## 1.1 Interface Description

Figure 1-1 shows a simplified block diagram of the MRF24J40MA module. The module is based on the Microchip Technology MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver IC. The module interfaces to many popular Microchip PIC® microcontrollers via a 4-wire serial SPI interface, interrupt, wake, Reset, power and ground, as shown in Figure 1-2. Table 1-1 provides the pin descriptions.

Data communications with the MRF24J40MA module are documented in the “MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver Data Sheet” (DS39776). Refer to the MRF24J40 Data Sheet for specific serial interface protocol and register definitions.

**FIGURE 1-1: MRF24J40MA BLOCK DIAGRAM**



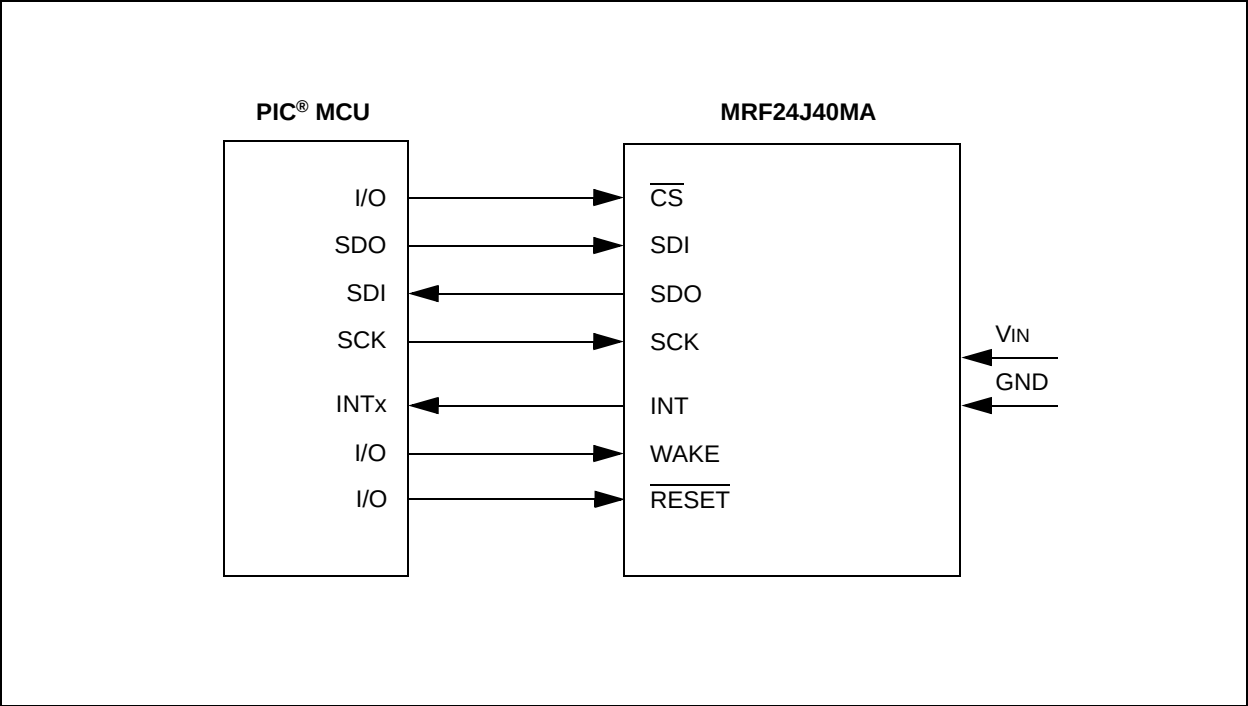
# MRF24J40MA

TABLE 1-1: PIN DESCRIPTION

| Pin | Symbol | Type   | Description                                               |
|-----|--------|--------|-----------------------------------------------------------|
| 1   | GND    | Power  | Ground                                                    |
| 2   | RESET  | DI     | Global hardware Reset pin                                 |
| 3   | WAKE   | DI     | External wake-up trigger                                  |
| 4   | INT    | DO     | Interrupt pin to microcontroller                          |
| 5   | SDI    | DI     | Serial interface data input                               |
| 6   | SCK    | DI     | Serial interface clock                                    |
| 7   | SDO    | DO     | Serial interface data output from MRF24J40                |
| 8   | CS     | DI     | Serial interface enable                                   |
| 9   | NC     | —      | No connection (allow pin to float; do not connect signal) |
| 10  | VIN    | Power  | Power supply                                              |
| 11  | GND    | Ground | Ground                                                    |
| 12  | GND    | Ground | Ground                                                    |

Legend: Pin type abbreviation: D = Digital, I = Input, O = Output

FIGURE 1-2: MICROCONTROLLER TO MRF24J40MA INTERFACE



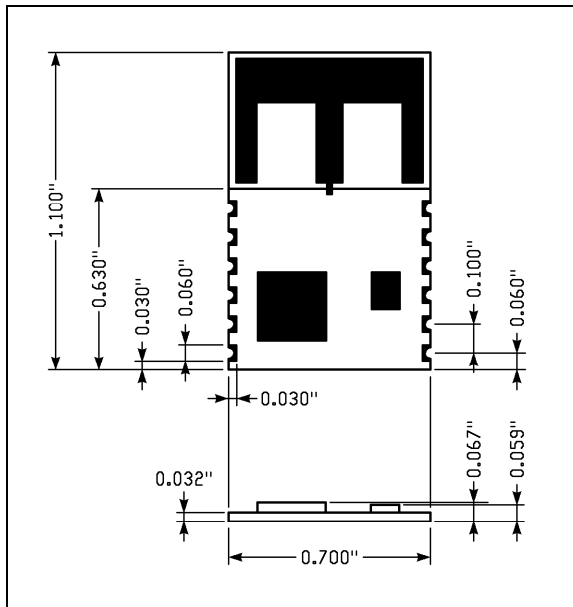
# MRF24J40MA

## 1.2 Mounting Details

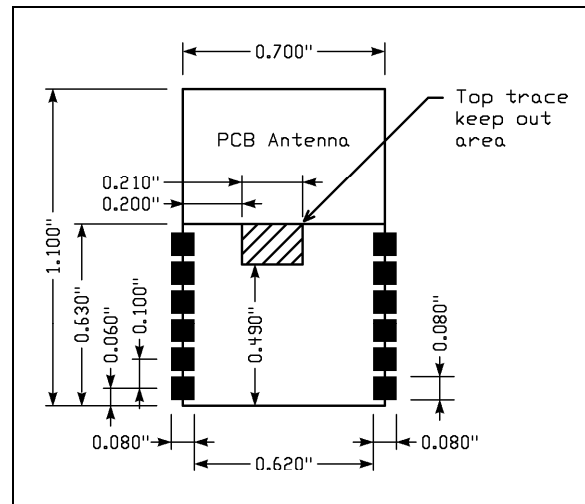
The MRF24J40MA is a surface mountable module. Module dimensions are shown in Figure 1-3. The module Printed Circuit Board (PCB) is 0.032" thick with castellated mounting points on the edge. Figure 1-4 is a recommended host PCB footprint for the MRF24J40MA.

The MRF24J40MA has an integrated PCB antenna. For the best performance, follow the mounting details shown in Figure 1-5. It is recommended that the module be mounted on the edge of the host PCB, and an area around the antenna, approximately 1.2", be kept clear of metal objects. A host PCB ground plane around the MRF24J40MA acts as a counterpoise to the PCB antenna. It is recommended to extend the ground plane at least 0.4" around the module.

### FIGURE 1-3: MODULE DETAILS

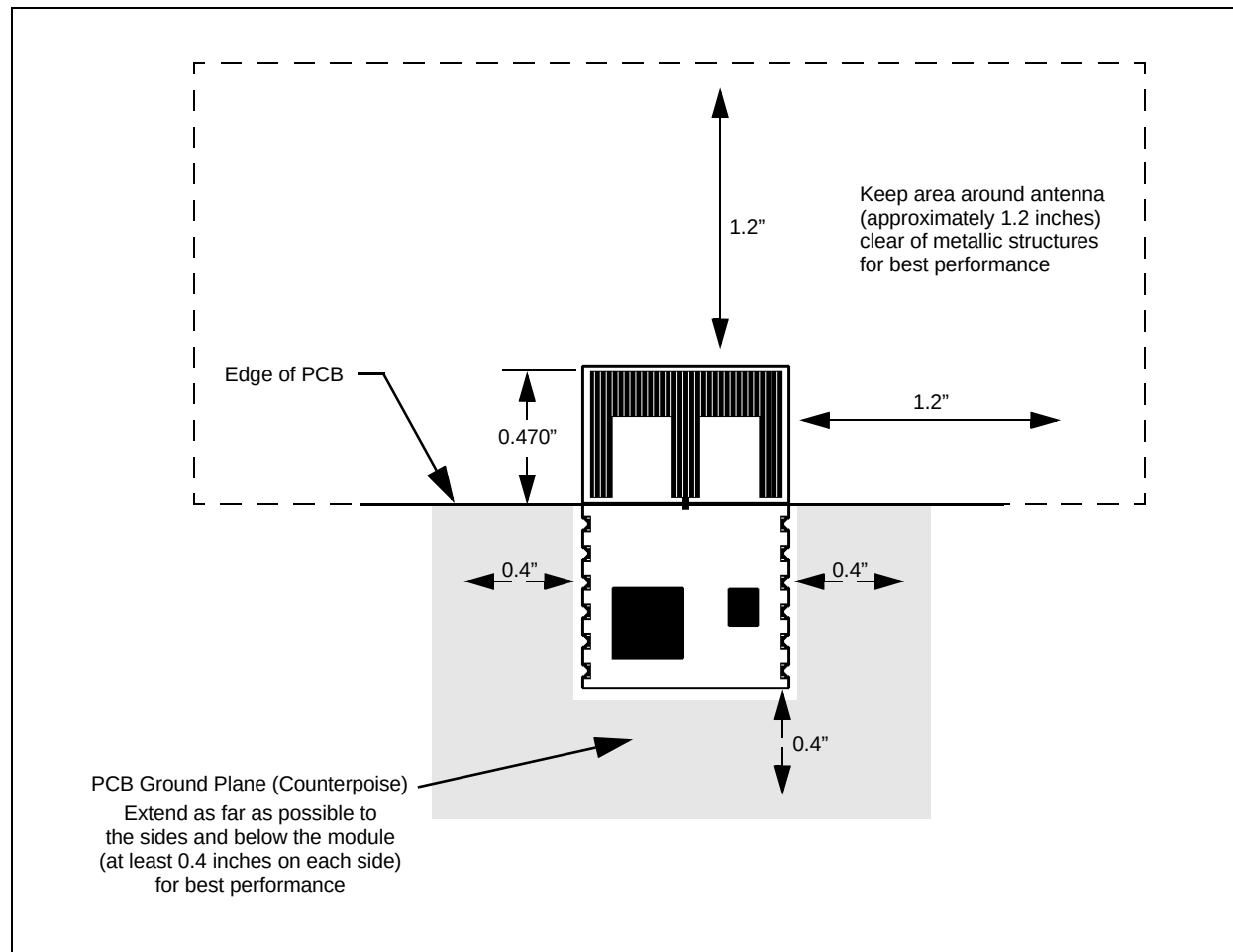


**FIGURE 1-4: RECOMMENDED PCB FOOTPRINT**



# MRF24J40MA

FIGURE 1-5: MOUNTING DETAILS



## 2.0 CIRCUIT DESCRIPTION

The MRF24J40MA is a complete 2.4 GHz IEEE Std. 802.15.4™ compliant surface mount module with integrated crystal, internal voltage regulator, matching circuitry and PCB antenna. The MRF24J40MA module interfaces to many popular Microchip PIC micro-controllers via a 4-wire serial SPI interface, interrupt, wake, Reset, power and ground. Data communications with the MRF24J40MA module are documented in the “*MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver Data Sheet*” (DS39776). Refer to the MRF24J40 Data Sheet for specific serial interface protocol and register definitions.

## 2.1 Schematic

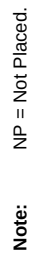
A schematic diagram of the module is shown in Figure 2-1 and the Bill of Materials (BOM) is shown in Table 2-1.

The MRF24J40MA module is based on the Microchip Technology MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver IC. The serial I/O (SCK, SDI, SDO and CS), RESET, WAKE and INT pins are brought out to the module pins. The SDO signal is tri-state buffered by IC2 to solve a silicon errata, where the SDO signal does not release to a high-impedance state, after the CS pin returns to its inactive state. Crystal, X1, is a 20 MHz crystal with a frequency tolerance of  $\pm 10$  ppm @ 25°C to meet the IEEE Std. 802.15.4 symbol rate tolerance of  $\pm 40$  ppm. A balun is formed by components: L1, L3, C2 and C14. L2 is an RF choke and pull-up for the RFP and RFN pins on the MRF24J40. C15 is a DC block capacitor. A low-pass filter is formed by components: L4, C16 and C17. The remaining capacitors provide RF and digital bypass.



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**TABLE 2-1: MRJ24J40MA BILL OF MATERIALS**

| Designator | Description                   | Manufacturer | Part Number           |
|------------|-------------------------------|--------------|-----------------------|
| C1         | Chip Capacitor 0402 X5R 1U    | Murata       | GRM155R60J105ME19D    |
| C2         | Chip Capacitor 0402 COG 1.0P  | Murata       | GRM1555C1H1R0CZ01D    |
| C3         | Chip Capacitor 0402 X7R 10N   | Murata       | GRM155R71E103KA01D    |
| C4         | Chip Capacitor 0402 COG 47P   | Murata       | GRM1555C1H470JZ01D    |
| C5         | Chip Capacitor 0402 COG 47P   | Murata       | GRM1555C1H470JZ01D    |
| C6         | Chip Capacitor 0402 COG 47P   | Murata       | GRM1555C1H470JZ01D    |
| C7         | Chip Capacitor 0402 X7R 10N   | Murata       | GRM155R71E103KA01D    |
| C8         | Chip Capacitor 0402 X5R 1U    | Murata       | GRM155R60J105ME19D    |
| C9         | Chip Capacitor 0402 COG 100P  | Murata       | GRM1555C1H101JZ01D    |
| C10        | Chip Capacitor 0402 COG 47P   | Murata       | GRM1555C1H470JZ01D    |
| C11        | Chip Capacitor 0402 X5R 100N  | Murata       | GRM155R61A104KA01D    |
| C12        | Chip Capacitor 0402 X5R 100N  | Murata       | GRM155R61A104KA01D    |
| C13        | Chip Capacitor 0402 COG 47P   | Murata       | GRM1555C1H470JZ01D    |
| C14        | Chip Capacitor 0402 COG 0.5P  | Murata       | GRM1555C1HR50CZ01D    |
| C15        | Chip Capacitor 0402 COG 0.5P  | Murata       | GRM1555C1HR50CZ01D    |
| C16        | Not Placed                    |              |                       |
| C17        | Chip Capacitor 0402 COG 1.0P  | Murata       | GRM1555C1H1R0CZ01D    |
| C18        | Chip Capacitor 0402 COG 18P   | Murata       | GRM1555C1H180JZ01D    |
| C19        | Chip Capacitor 0402 COG 18P   | Murata       | GRM1555C1H180JZ01D    |
| IC1        | IEEE 802.15.4™ RF Transceiver | Microchip    | MRF24J40-I/ML         |
| IC2        | Buffer, SC70 Package          | Fairchild    | NC7SZ125P5X           |
| L1         | Chip Inductor 0402 8.2N       | Panasonic    | ELJ-RF8N2JFB          |
| L2         | Chip Inductor 0402 3.3N       | Panasonic    | ELJ-RF3N3DFB          |
| L3         | Chip Inductor 0402 5.6N       | Panasonic    | ELJ-RF5N6DFB          |
| L4         | Chip Inductor 0402 6.8N       | Panasonic    | ELJ-RF6N8JFB          |
| R1         | Not Placed                    |              |                       |
| X1         | 20 MHz Crystal                | Abracon      | ABM8-156-20.0000MHZ-T |

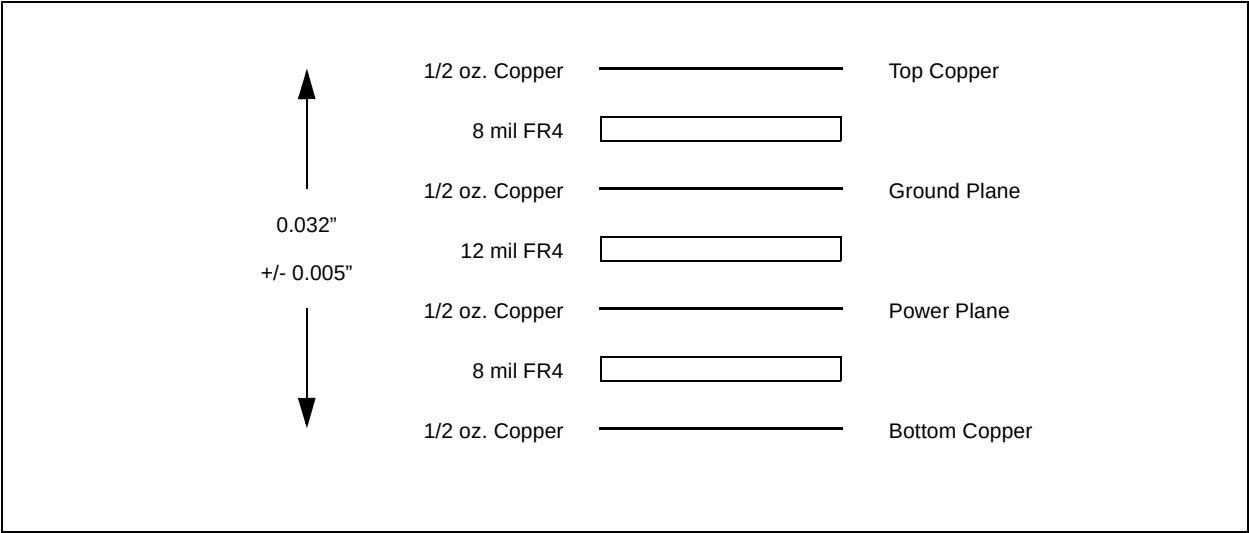
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The MRF24J40MA module printed circuit board is constructed with FR4 material, four layers and 0.032 inches thick. The layers are shown in Figure 2-2 through Figure 2-6. The stack up of the PCB is shown in Figure 2-7.

The image shows a top view negative Gerber of a PCB layout. It features a large black rectangular area on the left, representing a solid copper pour or a non-drilled region. To the right of this area is a white rectangular region containing a complex pattern of circular vias and rectangular pads. The vias are represented by small circles, and the pads are represented by larger circles or rectangles. The pattern is dense and irregular, with many small circles scattered throughout the white area. The entire layout is enclosed in a black rectangular border.

**Note:** Top view.

FIGURE 2-7: PCB LAYER STACK UP

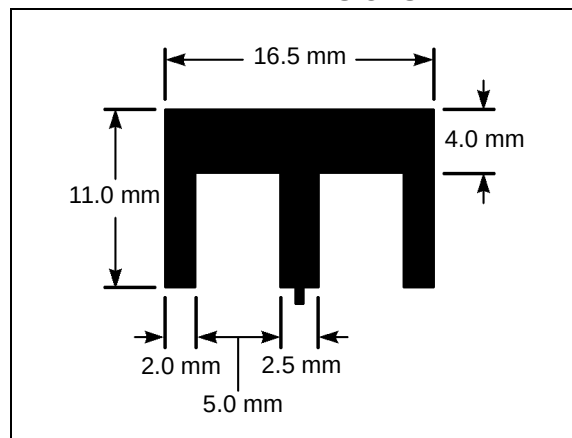


## 2.3 PCB Antenna

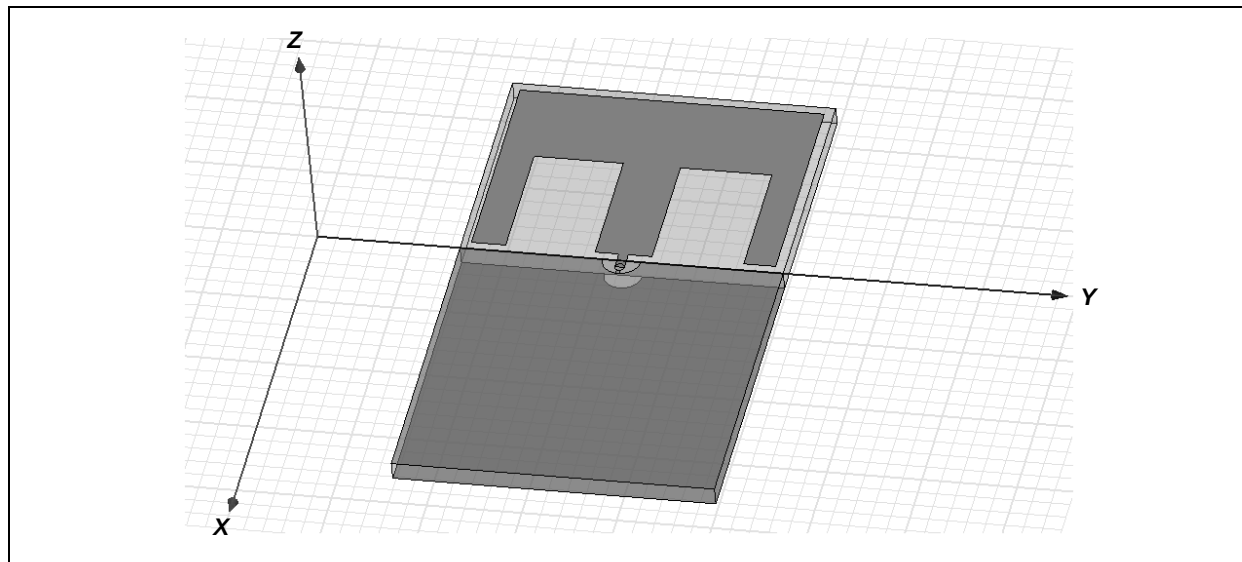
The PCB antenna is fabricated on the top copper trace. Figure 2-8 shows the trace dimensions. The layers below the antenna have no copper traces. The ground and power planes under the components serve as a counterpoise to the PCB antenna. Additional ground plane on the host PCB will substantially enhance the performance of the module. For best performance, place the module on the host PCB following the recommendations in **Section 1.2 “Mounting Details”**.

The Printed Circuit Board (PCB) antenna was designed and simulated using Ansoft Designer® and HFSS™ 3D full-wave solver software by Ansoft Corporation ([www.ansoft.com](http://www.ansoft.com)). The design goal was to create a compact, low-cost antenna with the best radiation pattern. Figure 2-9 shows the simulation drawing and Figure 2-10 and Figure 2-11 show the 2D and 3D radiation patterns, respectively. As shown by the radiation patterns, the performance of the antenna is dependant upon the orientation of the module. Figure 2-12 shows the impedance simulation and Figure 2-13 shows the actual impedance measurement. The discrete matching circuitry matches the impedance of the antenna with the MRF24J40 transceiver IC.

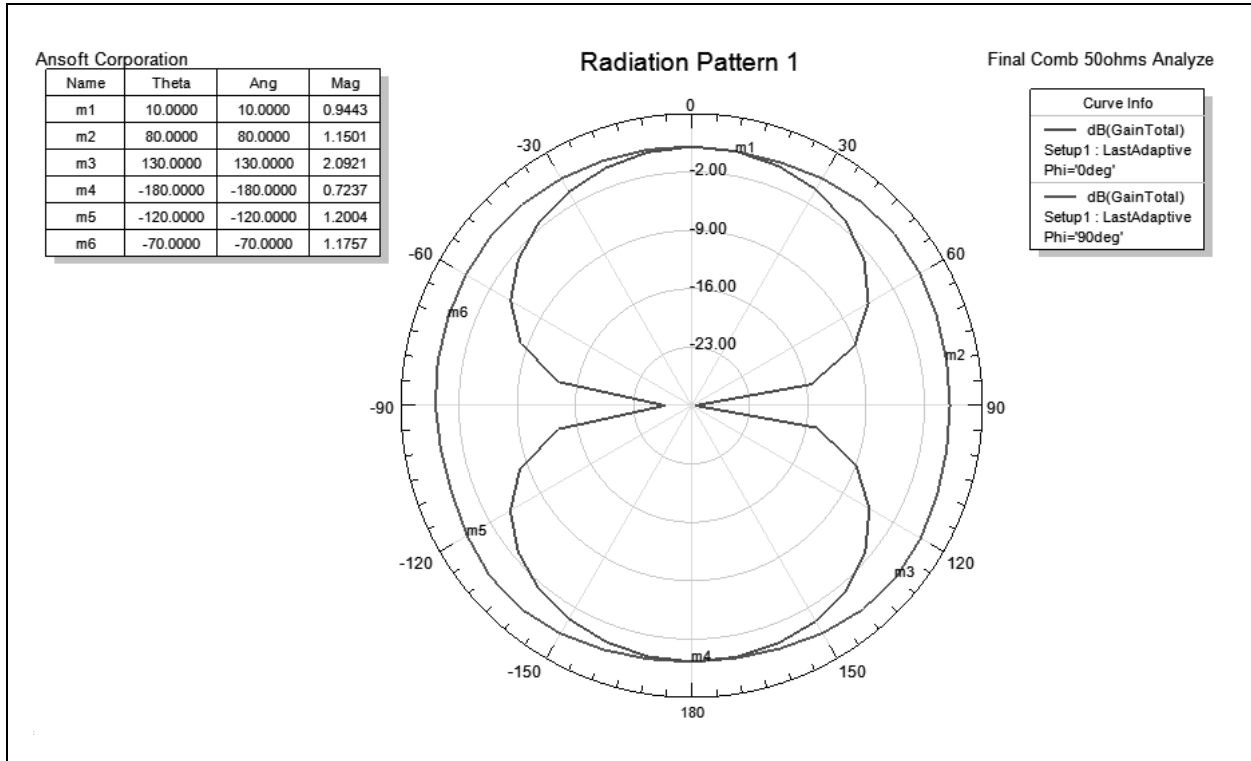
**FIGURE 2-8: PCB ANTENNA DIMENSIONS**



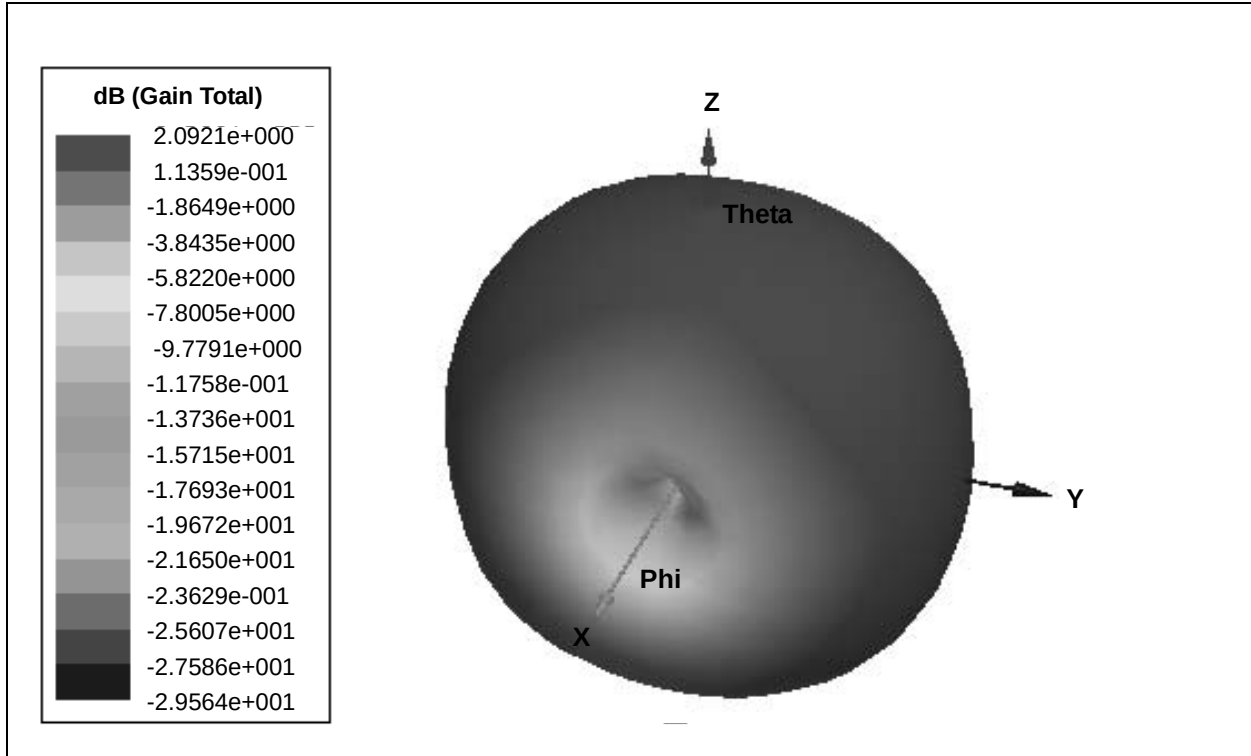
**FIGURE 2-9: PCB ANTENNA SIMULATION DRAWING**



**FIGURE 2-10: SIMULATED 2D RADIATION PATTERN**



**FIGURE 2-11: SIMULATED 3D RADIATION PATTERN**



# MRF24J40MA

FIGURE 2-12: SIMULATED PCB ANTENNA IMPEDANCE

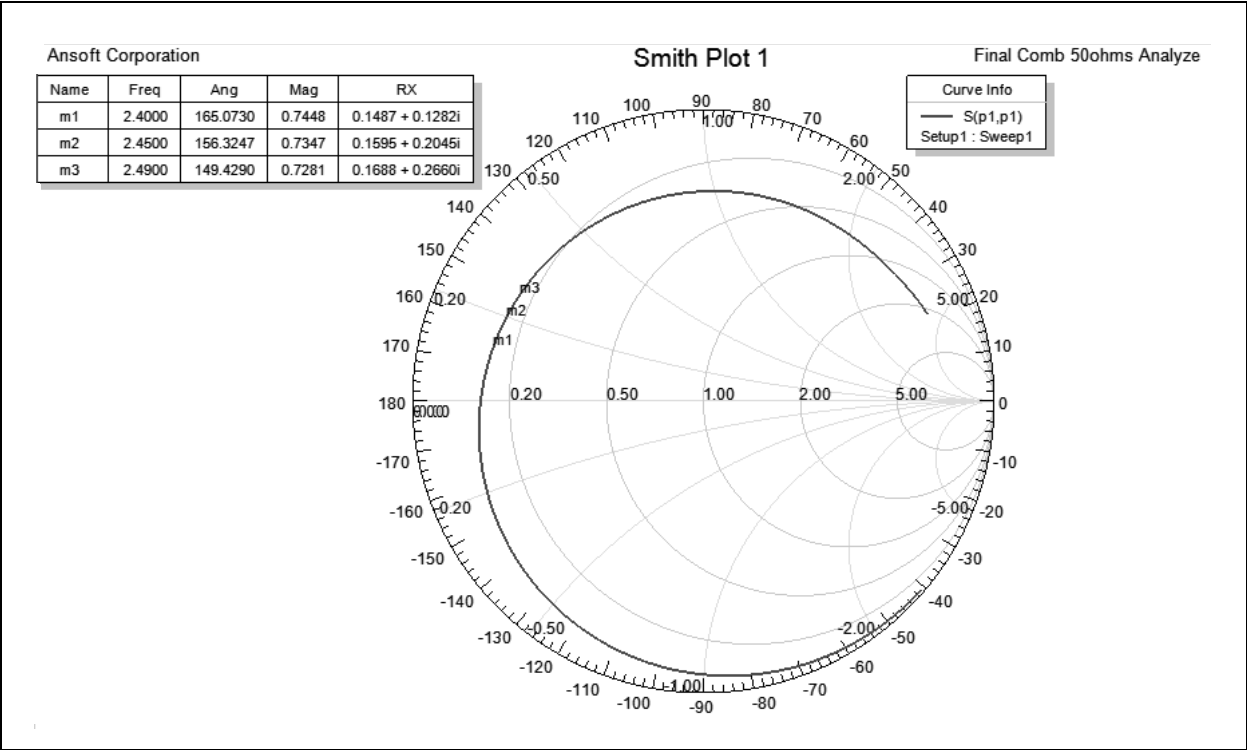
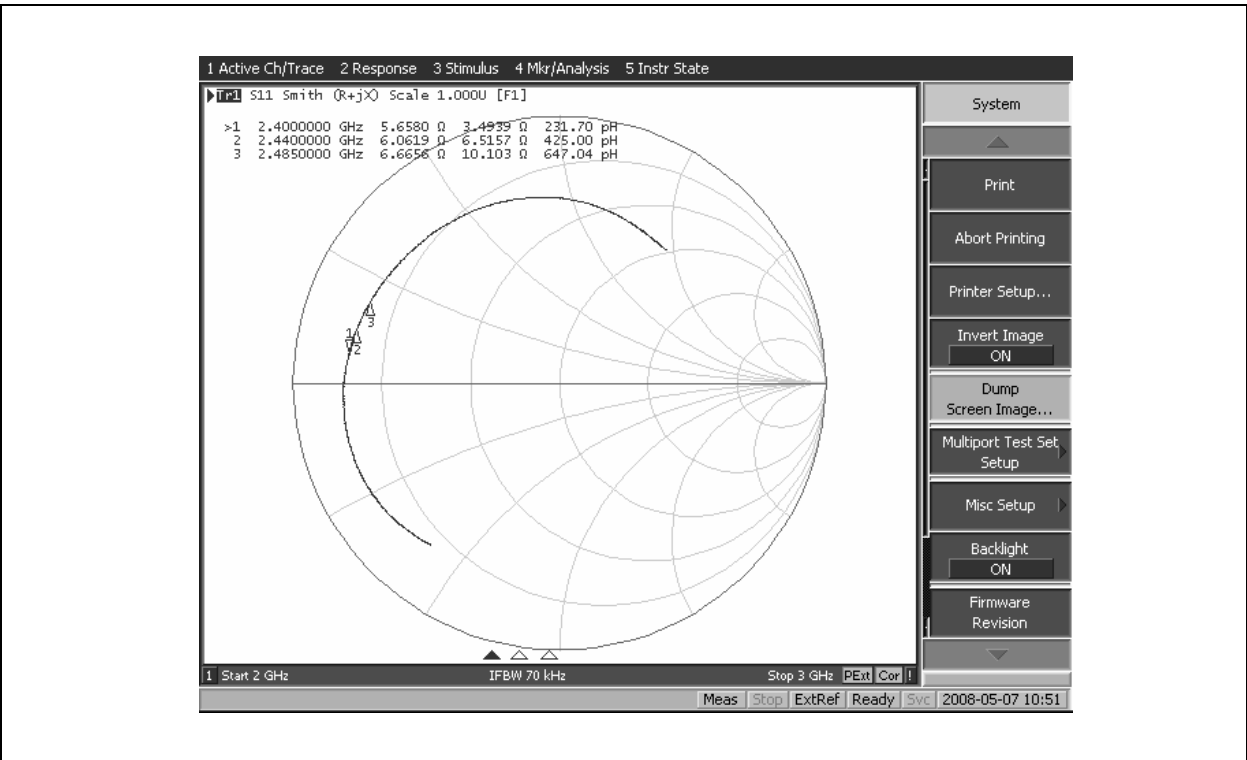


FIGURE 2-13: MEASURED PCB ANTENNA IMPEDANCE



## 3.0 REGULATORY APPROVAL

The MRF24J40MA module has received regulatory approvals for modular devices in the United States, Canada and European countries. Modular approval allows the end user to place the MRF24J40MA module inside a finished product and not require regulatory testing for an intentional radiator (RF transmitter), provided no changes or modifications are made to the module circuitry. Changes or modifications could void the user's authority to operate the equipment. The end user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

The integrator may still be responsible for testing the end product for any additional compliance requirements required with this module installed (for example: digital device emission, PC peripheral requirements, etc.) in the specific country that the end device will be marketed.

Annex F of the IEEE Std. 802.15.4 document has a good summary of regulatory requirements in various countries concerning IEEE Std. 802.15.4 devices. The standard can be downloaded from the IEEE Standards web page: <http://standards.ieee.org/getieee802/802.15.html>.

Refer to the specific country radio regulations for details on regulatory compliance.

### 3.1 United States

The MRF24J40MA has received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Subpart C "Intentional Radiators" 15.247 and modular approval in accordance with FCC Public Notice DA 00-1407 Released: June 26, 2000, Part 15 Unlicensed Modular Transmitter Approval. The MRF24J40MA module can be integrated into a finished product without obtaining subsequent and separate FCC approvals.

The MRF24J40MA module has been labeled with its own FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

Contains Transmitter Module FCC ID:  
OA3MRF24J40MA  
-or-  
Contains FCC ID: OA3MRF24J40MA  
This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:  
(1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

The user's manual should include the following statement:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.1.1 RF EXPOSURE

All transmitters regulated by FCC must comply with RF exposure requirements. OET Bulletin 65 "Evaluating Compliance with FCC Guidelines for Human Exposure to Radio Frequency Electromagnetic Fields" provides assistance in determining whether proposed or existing transmitting facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC). The bulletin offers guidelines and suggestions for evaluating compliance.

If appropriate, compliance with exposure guidelines for mobile and unlicensed devices can be accomplished by the use of warning labels and by providing users with information concerning minimum separation distances from transmitting structures and proper installation of antennas.



# MRF24J40MA

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The following statement must be included as a CAUTION statement in manuals and OEM products to alert users of FCC RF Exposure compliance:

To satisfy FCC RF Exposure requirements for mobile and base station transmission devices, a separation distance of 20 cm or more should be maintained between the antenna of this device and persons during operation. To ensure compliance, operation at closer than this distance is not recommended.

The antenna(s) used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

If the MRF24J40MA module is used in a portable application (antenna is less than 20 cm from persons during operation), the integrator is responsible for performing Specific Absorption Rate (SAR) testing in accordance with FCC rules 2.1091.

### 3.1.2 HELPFUL WEB SITES

Federal Communications Commission (FCC):  
<http://www.fcc.gov>

## 3.2 Canada

The MRF24J40MA module has been certified for use in Canada under Industry Canada (IC) Radio Standards Specification (RSS) RSS-210 and RSS-Gen.

From Section 7.1.1, RSS-Gen, Issue 2, June 2007, Modular Transmitter Approval:

Host devices which contain separately certified modules do not need to be recertified, provided that they meet the following conditions:

- a) The host device, as a stand-alone unit without any separately certified modules, complies with all applicable Radio Standards Specifications.
- b) The host device and all the separately certified modules it contains jointly meet the RF exposure compliance requirements of RSS-102, if applicable.
- c) The host device complies with the certification labeling requirements of each of the modules it contains.

**Note:** Compliance of a module in its final configuration is the responsibility of the applicant. A host device will not be considered certified if the instructions regarding antenna configuration provided in the original description, of one or more separately certified modules it contains, were not followed

From Section 5.2, RSS-Gen, Issue 2, June 2007, Equipment Labels:

All Category I radio equipment intended for use in Canada shall permanently display on each transmitter, receiver or inseparable combination thereof, the applicant's name (i.e., manufacturer's name, trade name or brand name), model number and certification number. This information shall be affixed in such a manner as to not be removable except by destruction or defacement. The size of the lettering shall be legible without the aid of magnification, but is not required to be larger than 8-point font size. If the device is too small to meet this condition, the information can be included in the user manual upon agreement with Industry Canada.

Label:

Contains IC: 7693A-24J40MA

From Section 7.1.6, RSS-Gen, Issue 2, June 2007, Digital Circuits:

If the device contains digital circuitry that is not directly associated with the radio transmitter, the device shall also have to comply with ICES-003, Class A or B as appropriate, except for ICES-003 labeling requirements. The test data obtained (for the ICES-003 tests) shall be kept by the manufacturer or importer whose name appears on the equipment label, and made available to Industry Canada on request, for as long as the model is being marketed in Canada.

### 3.2.1 HELPFUL WEB SITES

Industry Canada: <http://www.ic.gc.ca/>

## 3.3 Europe

The MRF24J40MA module has been certified for use in European countries. The following testing has been completed:

Test standard ETSI EN 300 328 V1.7.1 (2006-10):

- Maximum Transmit Power
- Maximum EIRP Spectral Density
- Frequency Range
- Radiated Emissions

Test standards ETSI EN 301 489-1:2008 and ETSI EN 301 489-17:2008:

- Radiated Emissions
- Electro-Static Discharge
- Radiated RF Susceptibility

A helpful document that can be used as a starting point in understanding the use of Short Range Devices (SRD) in Europe is the European Radio Communications Committee (ERC) Recommendation 70-03 E, downloadable from the European Radio Communications Office (ERO): <http://www.ero.dk>.

The end user is responsible for ensuring compliance with harmonized frequencies and labeling requirements for each country the end device is marketed and sold.

### 3.3.1 HELPFUL WEB SITES:

Radio and Telecommunications Terminal Equipment (R&TTE):

[http://ec.europa.eu/enterprise/rtte/index\\_en.htm](http://ec.europa.eu/enterprise/rtte/index_en.htm)

European Conference of Postal and Telecommunications Administrations (CEPT): <http://www.cept.org/>

European Telecommunications Standards Institute (ETSI): <http://www.etsi.org/>

European Radio Communications Office (ERO): <http://www.ero.dk/>

# MRF24J40MA

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NOTES:

## 4.0 ELECTRICAL CHARACTERISTICS

**TABLE 4-1: RECOMMENDED OPERATING CONDITIONS**

| Parameters                                         | Min                   | Typ | Max                   | Units |
|----------------------------------------------------|-----------------------|-----|-----------------------|-------|
| Ambient Operating Temperature                      | -40                   | —   | +85                   | °C    |
| Supply Voltage for RF, Analog and Digital Circuits | 2.4                   | —   | 3.6                   | V     |
| Supply Voltage for Digital I/O                     | 2.4                   | 3.3 | 3.6                   | V     |
| Input High Voltage (V <sub>IH</sub> )              | 0.5 x V <sub>DD</sub> | —   | V <sub>DD</sub> + 0.3 | V     |
| Input Low Voltage (V <sub>IL</sub> )               | -0.3                  | —   | 0.2 x V <sub>DD</sub> | V     |

**TABLE 4-2: CURRENT CONSUMPTION**

(T<sub>A</sub> = 25°C, V<sub>DD</sub> = 3.3V)

| Chip Mode | Condition               | Min | Typ | Max | Units |
|-----------|-------------------------|-----|-----|-----|-------|
| Sleep     | Sleep Clock Disabled    | —   | 2   | —   | μA    |
| TX        | At Maximum Output Power | —   | 23  | —   | mA    |
| RX        |                         | —   | 19  | —   | mA    |

**TABLE 4-3: RECEIVER AC CHARACTERISTICS**

Typical values are at T<sub>A</sub> = 25°C, V<sub>DD</sub> = 3.3V, LO Frequency = 2.445 GHz

| Parameters                        | Condition                                                             | Min   | Typ | Max   | Units |
|-----------------------------------|-----------------------------------------------------------------------|-------|-----|-------|-------|
| RF Input Frequency                | Compatible to IEEE Std. 802.15.4™, 2003                               | 2.405 | —   | 2.480 | GHz   |
| RF Sensitivity                    |                                                                       | —     | -94 | —     | dBm   |
| Maximum RF Input                  |                                                                       | +5    | —   | —     | dBm   |
| LO Leakage                        | Measured at Balun Matching Network Input at Frequency, 2.405-2.48 GHz | —     | -60 | —     | dBm   |
| Input Return Loss                 | Externally Matched to 50 ohm Source by a Balun Matching Network       | -8    | -12 | —     | dB    |
| Noise Figure (including matching) |                                                                       | —     | 8   | —     | dB    |
| Adjacent Channel Rejection        | @ +/-5 MHz                                                            | 30    | —   | —     | dB    |
| Alternate Channel Rejection       | @ +/-10 MHz                                                           | 40    | —   | —     | dB    |
| RSSI Range                        |                                                                       | —     | 50  | —     | dB    |
| RSSI Error                        |                                                                       | -5    | —   | 5     | dB    |

# MRF24J40MA

**TABLE 4-4: TRANSMITTER AC CHARACTERISTICS**

Typical values are at TA = 25°C, VDD = 3.3V, LO Frequency = 2.445 GHz

| Parameters                         | Condition                                         | Min   | Typ  | Max   | Units |
|------------------------------------|---------------------------------------------------|-------|------|-------|-------|
| RF Carrier Frequency               |                                                   | 2.405 | —    | 2.480 | GHz   |
| Maximum RF Output Power            |                                                   | —     | 0    | —     | dBm   |
| RF Output Power Control Range      |                                                   | —     | 36   | —     | dB    |
| TX Gain Control Resolution         | Programmed by Register                            | —     | 1.25 | —     | dB    |
| Carrier Suppression                |                                                   | —     | -30  | —     | dBc   |
| TX Spectrum Mask for O-QPSK Signal | Offset Frequency > 3.5 MHz, at 0 dBm Output Power | -33   | —    | —     | dBm   |
| TX EVM                             |                                                   | —     | 15   | —     | %     |

## APPENDIX A: REVISION HISTORY

### Revision A (June 2008)

Original data sheet for the MRF24J40MA device.

### Revision B (November 2008)

Changed C17 to 1.0 pF and removed CLKOUT signal.

# MRF24J40MA

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NOTES:

## INDEX

### A

|                     |    |
|---------------------|----|
| AC Characteristics  |    |
| Receiver .....      | 19 |
| Transmitter .....   | 20 |
| Antenna Impedance   |    |
| Measured PCB .....  | 14 |
| Simulated PCB ..... | 14 |

### B

|                                               |   |
|-----------------------------------------------|---|
| Block Diagrams                                |   |
| Microcontroller to MRF24J40MA Interface ..... | 4 |
| MRF24J40MA .....                              | 3 |

### C

|                                            |    |
|--------------------------------------------|----|
| Circuit Description .....                  | 7  |
| Customer Change Notification Service ..... | 24 |
| Customer Notification Service .....        | 24 |
| Customer Notification System .....         | 2  |
| Customer Support .....                     | 24 |

### E

|                                           |    |
|-------------------------------------------|----|
| Electrical Characteristics .....          | 19 |
| Current Consumption .....                 | 19 |
| Recommended Operating Conditions .....    | 19 |
| Errata .....                              | 2  |
| European Radio Communications (ERC) ..... | 17 |

### F

|                                  |    |
|----------------------------------|----|
| FCC ID Number .....              | 15 |
| FCC RF Exposure Compliance ..... | 16 |

### H

|                         |        |
|-------------------------|--------|
| Helpful Web Sites ..... | 16, 17 |
|-------------------------|--------|

### I

|                             |    |
|-----------------------------|----|
| Interface Description ..... | 3  |
| Internet Address .....      | 24 |

### M

|                                          |      |
|------------------------------------------|------|
| MAC/Baseband Features .....              | 1    |
| Microchip Internet Web Site .....        | 24   |
| MiWi P2P .....                           | 3    |
| MiWi Protocol .....                      | 3    |
| More Information .....                   | 2    |
| Customer Notification System .....       | 2    |
| Errata .....                             | 2    |
| Mounting Details .....                   | 5    |
| MRF24J40 Data Sheet .....                | 3, 7 |
| MRF24J40MA Bill of Materials (BOM) ..... | 9    |
| MRF24J40MA Schematic .....               | 8    |

### O

|                |   |
|----------------|---|
| Overview ..... | 3 |
|----------------|---|

### P

|                                   |    |
|-----------------------------------|----|
| PCB Antenna .....                 | 12 |
| Dimensions .....                  | 12 |
| Simulation Drawing .....          | 12 |
| PCB Layers                        |    |
| Bottom Copper .....               | 10 |
| Layer 2 – Ground Plane .....      | 10 |
| Layer 3 – Power Plane .....       | 10 |
| Stack Up .....                    | 11 |
| Top Copper .....                  | 10 |
| Top Silk Screen .....             | 10 |
| Pin Description .....             | 4  |
| Pin Diagram .....                 | 1  |
| Printed Circuit Board (PCB) ..... | 10 |

### R

|                           |    |
|---------------------------|----|
| Radiation Pattern         |    |
| 2D .....                  | 13 |
| 3D .....                  | 13 |
| Reader Response .....     | 25 |
| Regulatory Approval ..... | 15 |
| Canada .....              | 16 |
| Europe .....              | 17 |
| United States .....       | 15 |
| Revision History .....    | 21 |
| RF Exposure .....         | 15 |
| RF/Analog Features .....  | 1  |

### S

|                                      |    |
|--------------------------------------|----|
| Serial I/O                           |    |
| SCK, SDI, SDO, $\overline{CS}$ ..... | 7  |
| Short Range Devices (SRD) .....      | 17 |
| Specific Absorption Rate (SAR) ..... | 16 |
| SPI .....                            | 7  |

### W

|                            |    |
|----------------------------|----|
| WWW Address .....          | 24 |
| WWW, On-Line Support ..... | 2  |

### Z

|                       |   |
|-----------------------|---|
| ZigBee Protocol ..... | 3 |
|-----------------------|---|



# MRF24J40MA

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NOTES:

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1. What are the best features of this document?

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To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

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|-------------------|---------------------------------------|-------------------------------|---------------|-------------------|
| Device            | Module                                | Module Type                   | Tape and Reel | Temperature Range |
| Device            | MRF24J40MA;<br>VDD range 2.4V to 3.6V |                               |               |                   |
| Temperature Range | I                                     | = -40°C to +85°C (Industrial) |               |                   |

Examples:  
a) MRF24J40MA-I = Industrial temp. tray  
b) MRF24J40MAT-I = Industrial temp., tape and reel.



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